

HSP

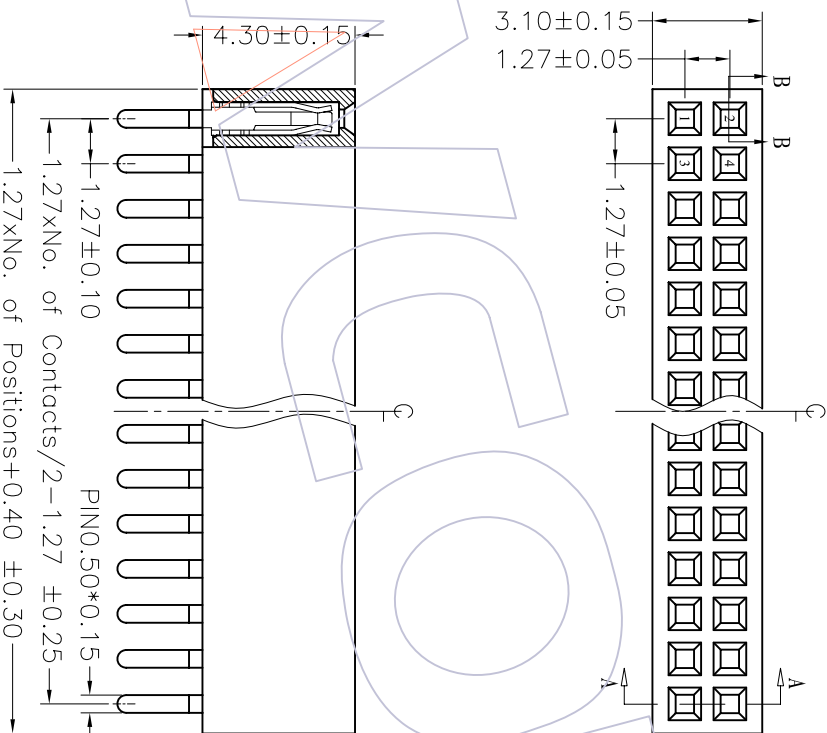
NOTES:

Current Rating: 1.0AMP
 Withstand Voltage: 500V AC/DC
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩMin
 Operation Temperature: -40°C to +105°C
 Contact Material: Phosphor Bronze
 Contact plating: Au or Sn over Ni
 Insulator Material: PA6T+30%G, F UL94V-0

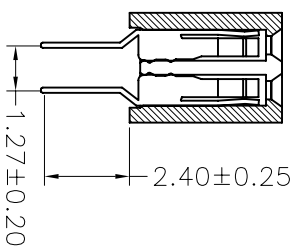
Ordering Information

2344 - 2 XX S XX CUNT 1

No. of Pins per Row: 42=50PIN
 Contact Plating: Co=Gold Flash
 G1=3μ"Gold
 G2=5μ"Gold
 G3=10μ"Gold
 G4=15μ"Gold
 G5=30μ"Gold
 SP=Gold Flash/Tin
 S1=3μ"Gold/Tin
 S2=5μ"Gold/Tin
 S3=10μ"Gold/Tin
 S4=15μ"Gold/Tin
 S5=30μ"Gold/Tin
 SN=Tin

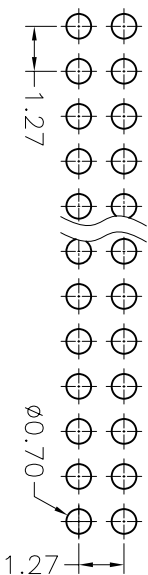


SECTION B-B



SECTION A-A

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION		DRAW		SCALE		PART NO.	TITLE:
					XXX	±0.40	DESIGN	UNIT	3:1	mm		
A0	08/02/16	NEW			XXX	±0.25	CHECK	SIZE	A4	1/1	2344-2XXSXXCUNT1	FHL 27mm DUAL 180° H=4.30
					Angle	± 3'	APPROVE	SHEET	1/1	Customer NO.		

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